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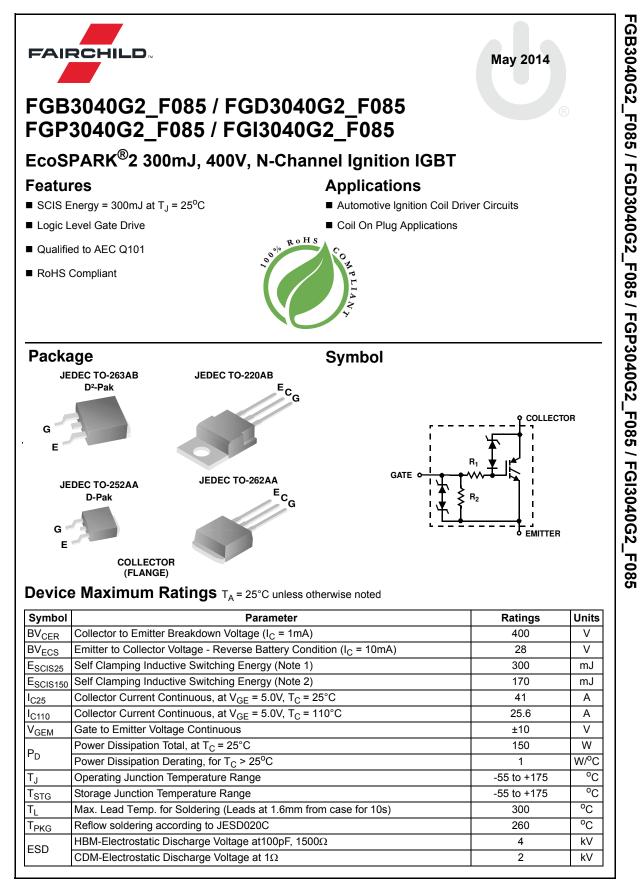
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Devic	ce Marking Device		Package Reel Size Tap		Tape Width	า	Quantity	
FGE	B3040G2 FGB3040G2_F085		TO-263AB	330mm	24mm		800	
FGI	FGD3040G2 FGD3040G2_F085		TO-252AA	330mm	mm 16mm		2500	
FGF	23040G2	FGP3040G2_F085	TO-220AB	Tube	N/A		50)
FGI3040G2 FGI3040G2_F085		TO-262AA	TO-262AA Tube		N/A		50	
Electr	ical Char	acteristics T _A = 25°	C unless otherwise note	ed				
Symbol		Parameter	Test Con	ditions	Min	Тур	Max	Units
Aff Sta	te Characte	oristics						
			$1 - 2mA \lambda (-0)$			1		1
BV _{CER}	Collector to Emitter Breakdown Voltage		$I_{CE} = 2mA, V_{GE} = 0,$ $R_{GE} = 1K\Omega,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		370	400	430	V
BV _{CES}	Collector to Emitter Breakdown Voltage		I _{CE} = 10mA, V _{GE} = 0V,			420	450	v
BV _{ECS}	Emitter to Collector Breakdown Voltage		$l_{of} = -20 \text{mA} $		28	-	-	V
BV _{GES}	Gate to Emitter Breakdown Voltage		I _{GES} = ±2mA		±12	±14	-	V
	Collector to Emitter Leakage Current		V _{CE} = 250V, R _{GE} = 1K	$\Omega \begin{array}{c} T_{\rm J} = 25^{\circ}C \\ T_{\rm J} = 150^{\circ}C \end{array}$		-	25 1	μA mA
I _{ECS}	Emitter to Co	llector Leakage Current	V _{EC} = 24V,	$T_{\rm J} = 25^{\circ}C$ $T_{\rm J} = 150^{\circ}C$	-	-	1 40	mA
R ₁	Series Gate Resistance				-	120	-	Ω
R ₂	Gate to Emitt	er Resistance			10K	-	30K	Ω
	te Characte	eristics			I			<u> </u>
V _{CE(SAT)}	Collector to E	mitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	$T_{J} = 25^{\circ}C$		1.15	1.25	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage		I_{CE} = 10A, V_{GE} = 4.5V,			1.35	1.50	V
	Collector to Emitter Saturation Voltage		I _{CE} = 15A, V _{GE} = 4.5V,	T _J = 150 ^o		1.68	1.85	V

Thermal Characteristics

R _{0JC} Thermal Resistance Junction to Case
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Self Clamped Inductive Switching

Notes:

E_{SCIS}

1: Self Clamping Inductive Switching Energy (E_{SCIS25}) of 300 mJ is based on the test conditions that starting Tj=25°C; L=3mHy, I_{SCIS}=14.2A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

 $L = 3.0 \text{ mHy}, RG = 1K\Omega$,

VGE = 5V, (Note 1)

TJ = 25°C

2: Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 170 mJ is based on the test conditions that starting Tj=150°C; L=3mHy, I_{SCIS}=10.8A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

300

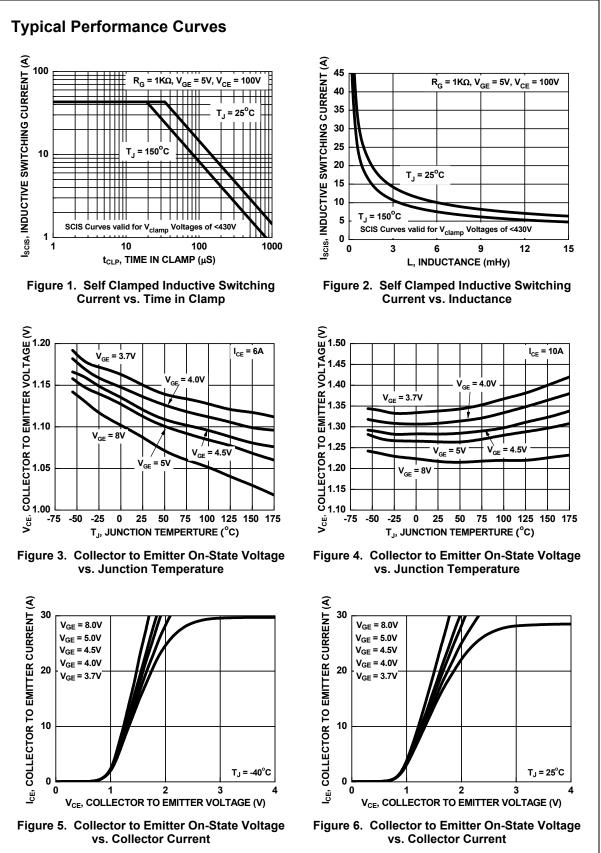
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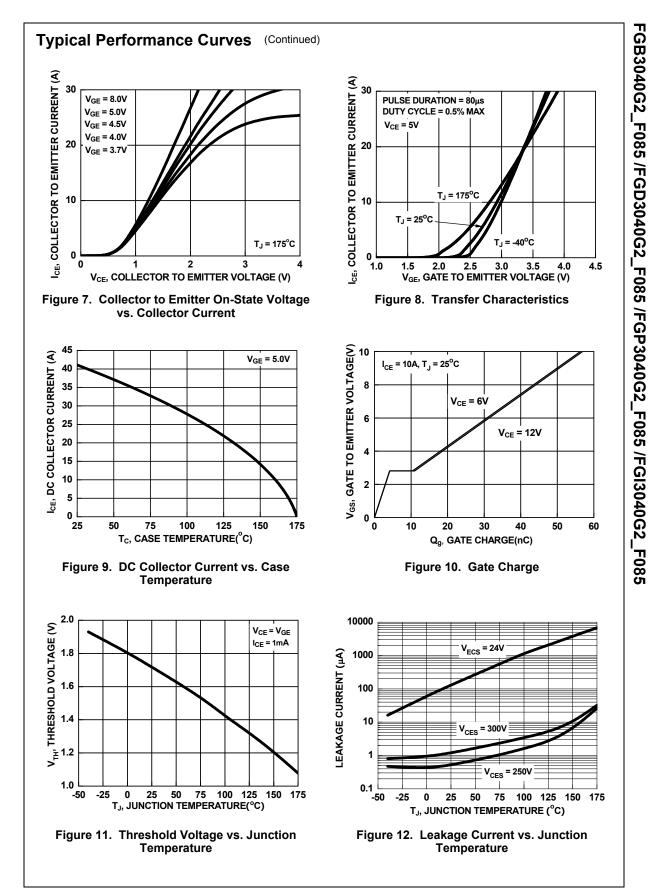
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mJ

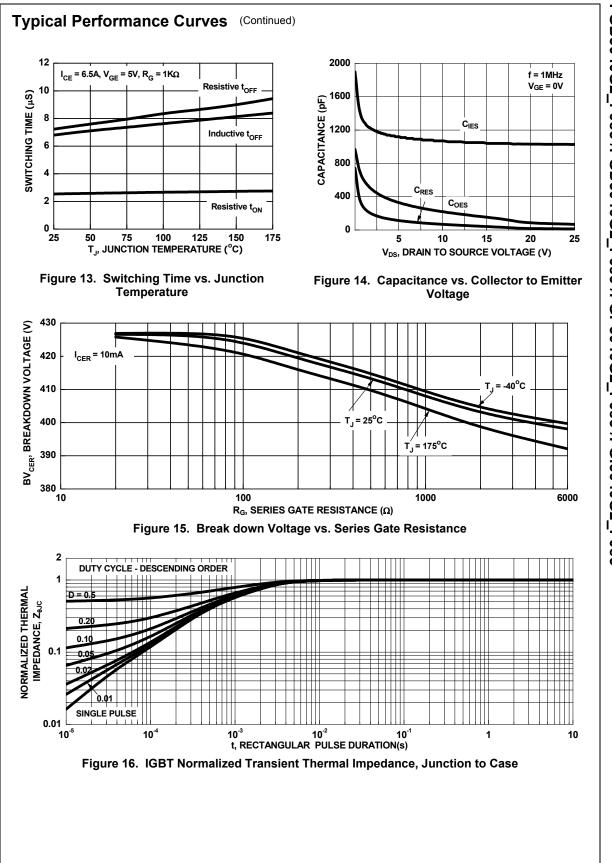
°C/W

ynamic Characteristics $\lambda_{G(DN)}$ Gate Charge $ CE = 10A, V_{CE} = 12V, CE = 12V, CE = 12V, CE = 12V, CE = 10A, V_{CE} = 10V, CE = 10V, C$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	G(ON)							
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $. ,							
$ \begin{array}{c} T_{GE(TH)} \\ T_{GE(TH)} \end{array} \begin{array}{c} \text{Gate to Emitter Threshold Voltage} \\ T_{GEP} \end{array} \begin{array}{c} T_{GE} = 1\text{mA}, V_{CE} = V_{GE}, \\ T_{J} = 150^{\circ}\text{C} \end{array} \begin{array}{c} 1.3 \\ T_{J} = 25^{\circ}\text{C} \end{array} \begin{array}{c} 1.3 \\ T_{J} = 150^{\circ}\text{C} \end{array} \begin{array}{c} 0.75 \\ 1.2 \\ T_{J} = 150^{\circ}\text{C} \end{array} \begin{array}{c} V \\ V \\ V \\ \hline \end{array} \end{array} \begin{array}{c} V \\ V $	$\begin{array}{c c} \hline F_{E(TH)} & \text{Gate to Emitter Threshold Voltage} & I_{CE} = 1\text{mA}, V_{CE} = V_{GE}, & \hline T_J = 25^{\circ}\text{C} & 1.3 & 1.7 & 2.2 \\ \hline T_J = 150^{\circ}\text{C} & 0.75 & 1.2 & 1.8 \\ \hline T_J = 150^{\circ}\text{C} & 0.75 & 1.2 & 1.8 \\ \hline T_J = 150^{\circ}\text{C} & 0.75 & 1.2 & 1.8 \\ \hline T_J = 150^{\circ}\text{C} & 0.75 & 1.2 & 1.8 \\ \hline T_J = 150^{\circ}\text{C} & 0.75 & 1.2 & 1.8 \\ \hline T_J = 150^{\circ}\text{C} & 0.75 & 1.2 & 1.8 \\ \hline T_J = 2.8 & - & V \\ \hline \textbf{itching Characteristics} \\ \hline \textbf{K}_{CE} = 14V, R_L = 1\Omega \\ \hline Current Turn-On Delay Time-Resistive & V_{CE} = 14V, R_L = 1\Omega \\ \hline Current Rise Time-Resistive & V_{GE} = 5V, R_G = 1K\Omega \\ \hline F_{F} \downarrow & Current Turn-Off Delay Time-Inductive & V_{CE} = 300V, L = 1\text{mH}, \\ \hline Output F_{CE} = 5V, R_G = 1K\Omega \\ \hline \end{array}$		Gate Charge			-	21	-	nC
GEPGate to Emitter Plateau Voltage $V_{CE} = 12V$, $I_{CE} = 10A$ $ 2.8$ $ V$ witching Characteristics(ON)RCurrent Turn-On Delay Time-Resistive $V_{CE} = 14V$, $R_L = 1\Omega$ $ 0.9$ 4 μs RCurrent Rise Time-Resistive $V_{CE} = 5V$, $R_G = 1K\Omega$ $ 1.9$ 7 μs (OFF)LCurrent Turn-Off Delay Time-Inductive $V_{CE} = 300V$, $L = 1mH$, $ 4.8$ 15 μs (OFF)LCurrent Turn-Off Delay Time-Inductive $V_{CE} = 30V$, $L = 1mH$, $ 4.8$ 15 μs	$\begin{array}{c} \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	JE(III)	Gate to Emitter Threshold Voltage						v
witching Characteristics $(ON)R$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs RCurrent Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs $(OFF)L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs $(OFF)L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs	itching CharacteristicsN)RCurrent Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs FF)LCurrent Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs Oursent Fail Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ -0.04.5 μs		Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A	1 _J = 150°C				V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	N)RCurrent Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs FF)LCurrent Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs Oursent Fail Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ -4.815 μs		-					I	
R_R Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ $T_J = 25^{\circ}C,$ -1.97 μs $\mu(OFF)L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ $V_{GE} = 5V, R_G = 1K\Omega$ -4.815 μs	Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ $T_J = 25^{\circ}C,$ -1.97 μs FF)LCurrent Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ $V_{GE} = 5V, R_G = 1K\Omega$ -4.815 μs		-	V _{CE} = 14V, R _L = 1Ω		-	0.9	4	μS
$\frac{1}{(OFF)L} Current Turn-Off Delay Time-Inductive}{V_{CE} = 300V, L = 1mH,} \frac{-4.8 15}{V_{GE} = 5V, R_G = 1K\Omega}$	$\frac{1}{1000} FF_{L} = 100 \text{ Current Turn-Off Delay Time-Inductive } V_{CE} = 300 \text{ V}, \text{ L} = 1 \text{ mH}, \\ V_{GE} = 5 \text{ V}, \text{ R}_{G} = 1 \text{ K} \Omega$			$V_{GE} = 5V, R_G = 1K\Omega$		-	1.9	7	μS
L Current Fall Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ $I_{CE} = 6.5A, T_J = 25^{\circ}C,$ - 2.0 15 µs	Current Fall Time-Inductive $V_{GE} = 5V$, $R_G = 1K\Omega$ - 2.0 15 μ s	(OFF)L	Current Turn-Off Delay Time-Inductive	V _{CE} = 300V, L = 1mH,		-	4.8	15	μS
			Current Fall Time-Inductive	$V_{GE} = 5V, R_G = 1K\Omega$		-	2.0	15	μs

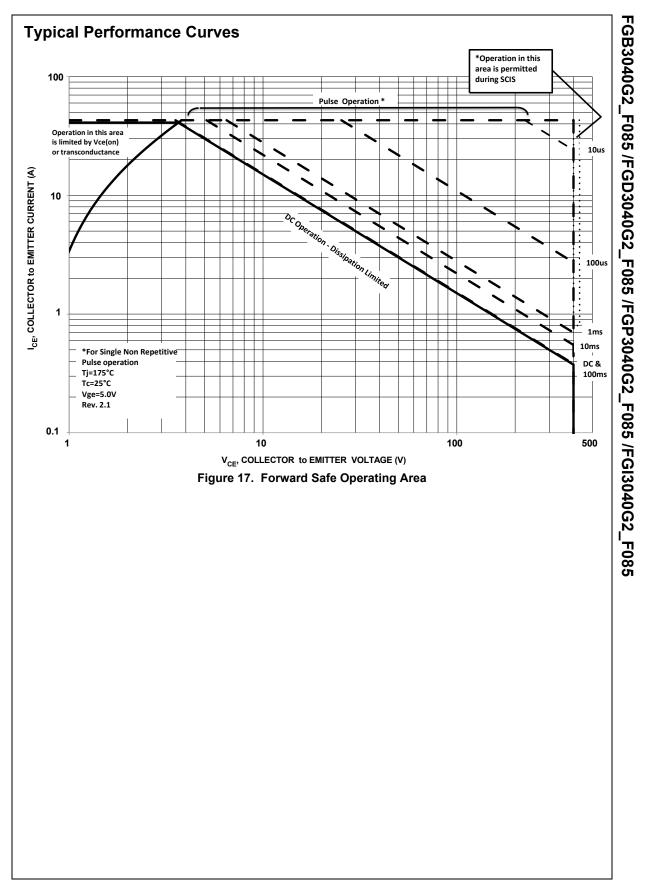


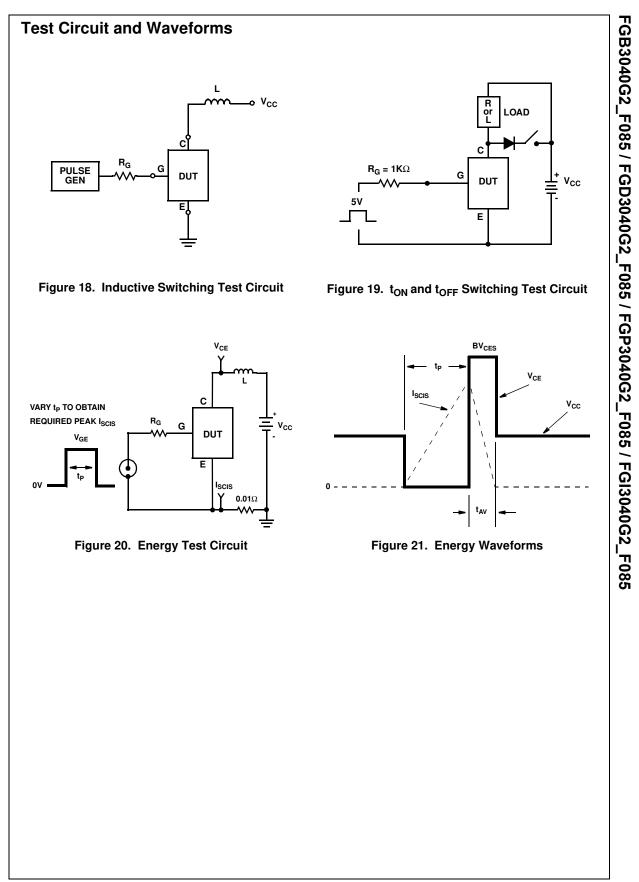


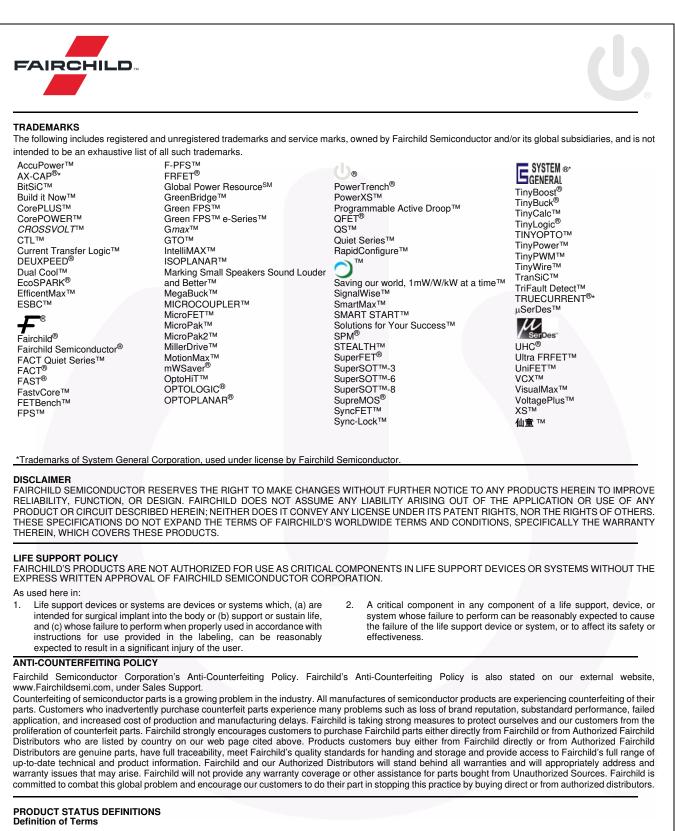
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